

SURF N PERFTM

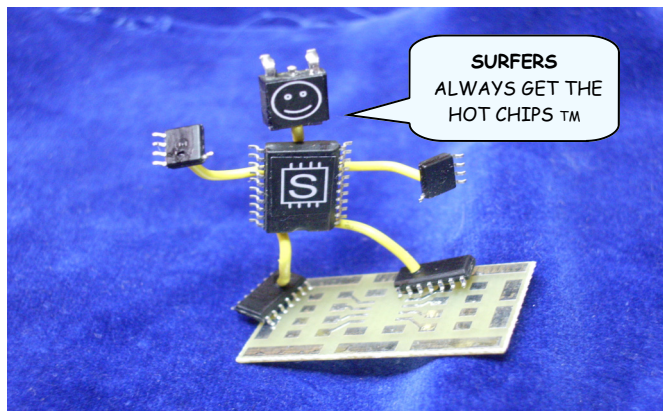
CIRCUIT SMORGASBOARDTM

WE MAKE BREADBOARDING *EASY*

Capital has been providing interconnect solutions for over 25 years. Our popular **SURFBOARDS** have been making Surface Mount technology easy and accessible to engineers, enthusiasts, and educators for over 15 years. Our patented* Universal Pad features greatly extend layout and component mounting options and can provide a more compact prototype with shorter more direct connections to peripheral components and devices. Simple hand soldering tools are often all that are needed to create prototypes with a wide range of components. See Bulletin **SM-EZ-101** for more information.

Capitals breadboards, adapters, and interconnect products can extend the classical breadboarding concept to Surface Mount as well as streamline the process by providing the perfect medium between the two worlds, often with better performance and lower cost.

In addition to standard products, Capital also offers a range of custom interconnect and manufacturing solutions from prototype to production. See the Menu for a partial listing of our board level products.



MENU ITEMS SERVED WITH YOUR CHOICE OF:



GREENSURFTM RoHS Lead Free Finish.

PitchGREENTM RoHS compliant process.

Traditional Lead based Technologies Available.



MENU

SURFBOARDS[®]

Surface Mount breadboards and adaptors. The original Surface Mount universal board. **BUILDING BLOCKS FOR SURFACE MOUNT**TM

UNI-SIPTM

Miniature breadboard modules for through hole components feature Single-In-Line pins on .100 in. centers.

BREADSTIXTM

Segmented breadboard strips can be user defined. Models feature both standard and universal patterns

SCOREBOARDTM

Larger form factor breadboards feature scores (breaklines) on grid that permit the user to define breadboard of desired size.

SCORECARDTM

Smaller form factor breadboards feature scores (breaklines) and both standard and universal patterns.

CARGO-CHIPTM

Custom Circuit Modules packaged in small form factor feature surface mount technology.

CARGO-DIPTM Custom circuit modules in DIP (dual-in-line) format.

CARGO-SIPTM Custom Circuit modules in SIP (single-in-line) format.

PitchPATCHTM

Convert one pitch to another. Surface Mount to Dip. Surface Mount to Surface Mount.

ProtoPATCHTM

Application specific circuit configurations extend breadboard versatility.

BULLETIN
SP-106

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